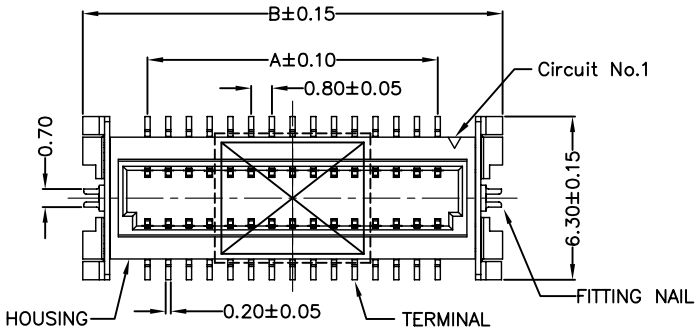
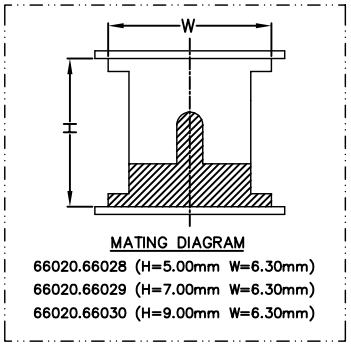
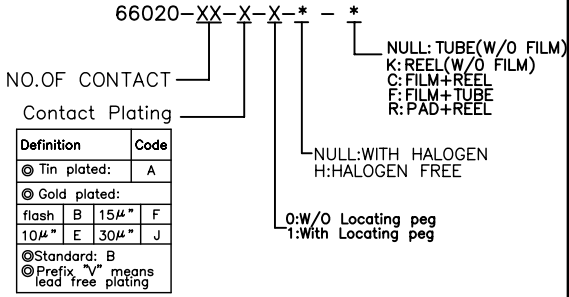
Circuit No.	Dim A	Dim B	Dim C
10	3.2	8.2	7.2
12	4.0	9.0	8.0
14	4.8	9.8	8.8
16	5.6	10.6	9.6
18	6.4	11.4	10.4
20	7.2	12.2	11.2
22	8.0	13.0	12.0
24	8.8	13.8	12.8
26	9.6	14.6	13.6
28	10.4	15.4	14.4
30	11.2	16.2	15.2
32	12.0	17.0	16.0
34	12.8	17.8	16.8
36	13.6	18.6	17.6
38	14.4	19.4	18.4
40	15.2	20.2	19.2
42	16.0	21.0	20.0
44	16.8	21.8	20.8
46	17.6	22.6	21.6
48	18.4	23.4	22.4
50	19.2	24.2	23.2
52	20.0	25.0	24.0
54	20.8	25.8	24.8
56	21.6	26.6	25.6
58	22.4	27.4	26.4
60	23.2	28.2	27.2
62	24.0	29.0	28.0
64	24.8	29.8	28.8
66	25.6	30.6	29.6
68	26.4	31.4	30.4
70	27.2	32.2	31.2
72	28.0	33.0	32.0
74	28.8	33.8	32.8
76	29.6	34.6	33.6
78	30.4	35.4	34.4
80	31.2	36.2	35.2
82	32.0	37.0	36.0
84	32.8	37.8	36.8
86	33.6	38.6	37.6
88	34.4	39.4	38.4
90	35.2	40.2	39.2
100	39.2	44.2	43.2

Rev.	ECN Number	Description	Drawn
8	CH10120135	換圖框，增加包裝圖	IVAN.LUI_11/29'10
9	EH12030030	變更"PAD"	XIHONG.LIU_03/05'12

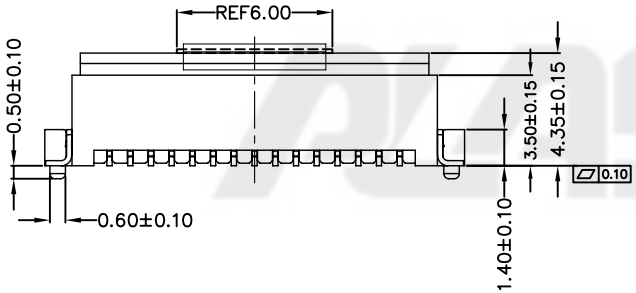


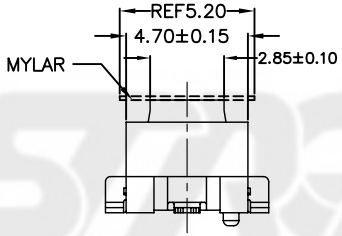


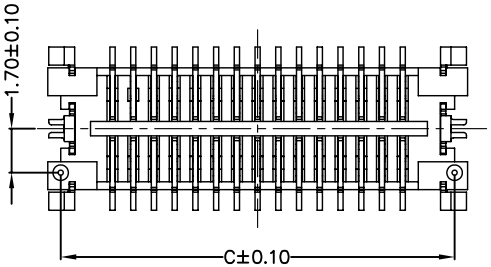
NOTES: (UNLESS OTHERWISE SPECIFIED)
1. DIMENSION SHALL BE INTERPRETED PER ANSI Y14.5M–1994
2. INSERTION FORCE: 150g MAX. PER CONTACT.
3. WITHDRAW FORCE: 25g MIN. PER CONTACT.
4. DURABILITY: 30 CYCLES MIN..
5. CONTACT RENTENTION FORCE: 200g MIN. PER CONTACT.
6. CURRENT RATING: 0.3 AMPERE.
7. CONTACT RESISTANCE: 70 m ohms MAX. FOR INITIAL.
8. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC rms./MINUTE.
9. INSULATION RESISTANCE: 100 Megohms MIN..
10. OPERATING TEMPERATURE: −40°~+105°C.
11. HARMFUL MATERIAL SHOULD BE COMPLIANT TO DOC. "EI−0005" STANDARDS.
12. PRODUCT NUMBER MATRIX:

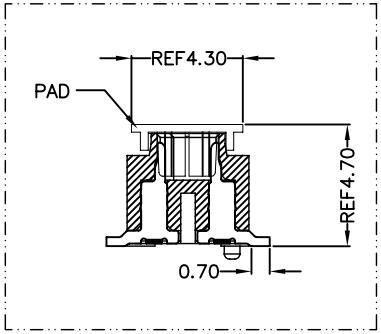


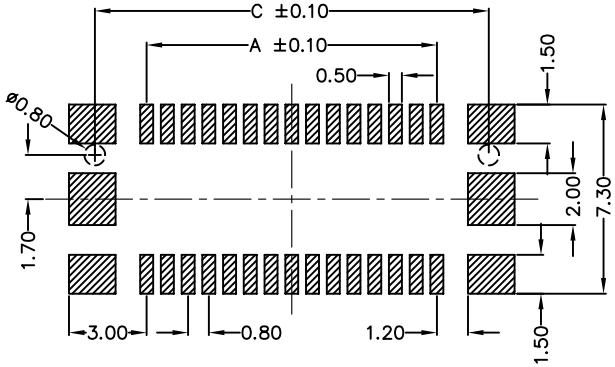
Definition	Code
◎ Tin plated:	A
◎ Gold plated:	
flash B 15μ" F	
10μ" E 30μ" J	
◎Standard: B ◎Prefix "V" means lead free plating	











RECOMMENDED P.C.B LAYOUT (TOP VIEW)
(PCB TOLERANCE:±0.05)

PLASTRON TECHNOLOGY (SHEN ZHEN) CO., LTD.

GENERAL TOLERANCE		SCALE N/A	ORIGINAL DRAWN XIHONG.LIU	DATE 03/09'11	DWG. NO. 600-0000-0140	TITLE CUSTOMER_DRAWING	REV. 9
XX. ±	XXX. ±						
X. ± 0.30	.XXX ±	UNIT MM	CHECK ———	DATE ———	PARTS NO.(INTENDED USE) 66020-**-*-*-*-*SERIES		SHEET 1/3
.X ± 0.25	X.° ± 3°						
.XX ± 0.20	.X° ± 2°	SIZE A4	APPROVE LANE SUN	DATE 03/05'12			